



# PBSS4041NX

60 V, 6.2 A NPN low V<sub>CEsat</sub> transistor

16 January 2025

Product data sheet

## 1. General description

NPN low V<sub>CEsat</sub> transistor in a medium power and flat lead SOT89 (SC-62) Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS4041PX

## 2. Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain ( $h_{FE}$ ) at high I<sub>C</sub>
- High energy efficiency due to less heat generation
- AEC-Q101 qualified

## 3. Applications

- Loadswitch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	60	V
I <sub>C</sub>	collector current		-	-	6.2	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	-	15	A
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	18	35	mΩ

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		
2	C	collector		
3	B	base		

## 6. Ordering information

**Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
PBSS4041NX	SOT89	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	<a href="#">SOT89</a>

## 7. Marking

**Table 4. Marking codes**

Type number	Marking code <a href="#">[1]</a>
PBSS4041NX	%6F

[1] % = placeholder for manufacturing site code

## 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter		-	60	V
$V_{CEO}$	collector-emitter voltage	open base		-	60	V
$V_{EBO}$	emitter-base voltage	open collector		-	5	V
$I_C$	collector current			-	6.2	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1$ ms		-	15	A
$I_B$	base current			-	1	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	600	mW
			[2]	-	1.5	W
			[3]	-	1.45	W
			[4]	-	2.45	W
			[5]	-	2.5	W
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C

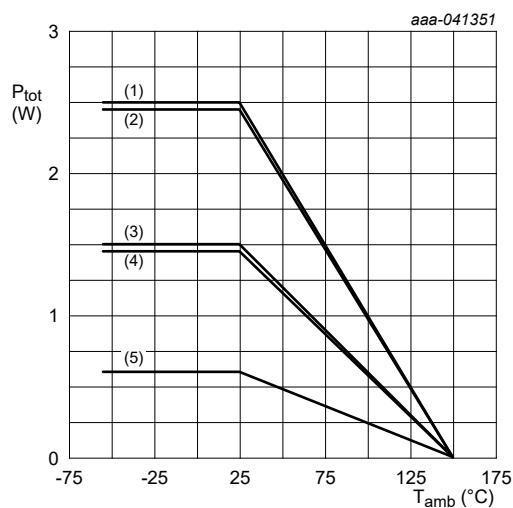
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided, 35 µm copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, single-sided, 35 µm copper, tin-plated and standard footprint.



- (1) Ceramic PCB,  $\text{Al}_2\text{O}_3$ , 35  $\mu\text{m}$  copper, standard footprint.  
 (2) FR4 PCB, 4-layer copper, 1  $\text{cm}^2$ .  
 (3) FR4 PCB, single-sided, 35  $\mu\text{m}$  copper, 6  $\text{cm}^2$ .  
 (4) FR4 PCB, 4-layer copper, standard footprint.  
 (5) FR4 PCB, single-sided, 35  $\mu\text{m}$  copper, standard footprint.

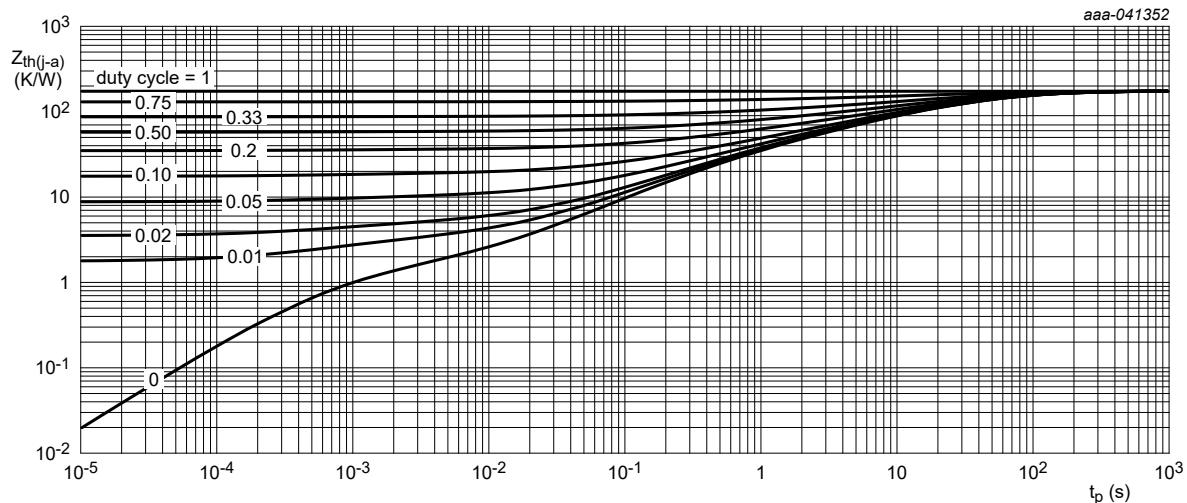
Fig. 1. Power derating curves

## 9. Thermal characteristics

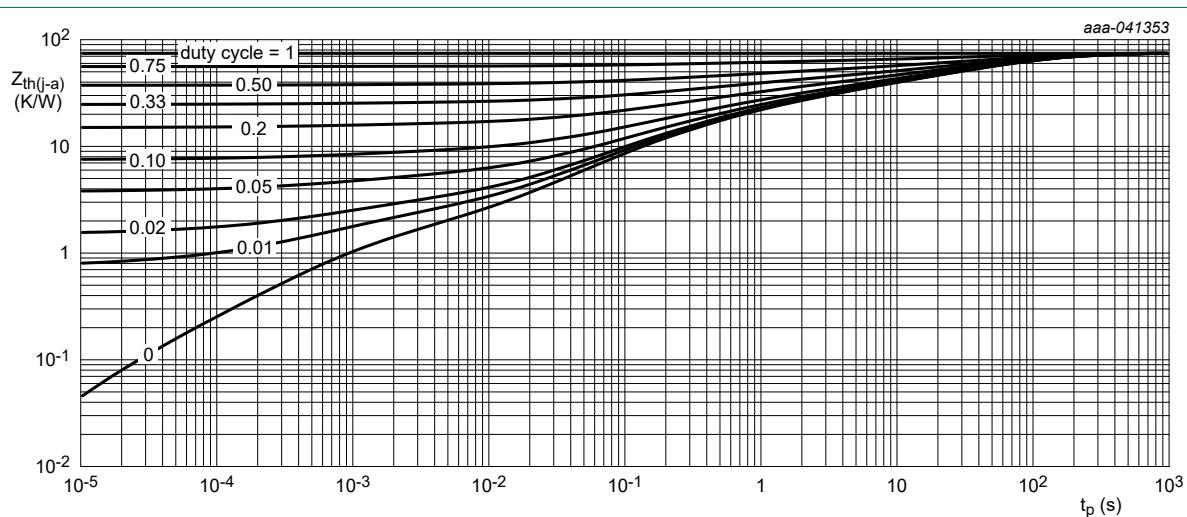
Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	[1]	-	-	208	K/W
			[2]	-	-	83	K/W
			[3]	-	-	86	K/W
			[4]	-	-	51	K/W
			[5]	-	-	50	K/W
$R_{\text{th(j-sp)}}$	thermal resistance from junction to solder point			-	-	20	K/W

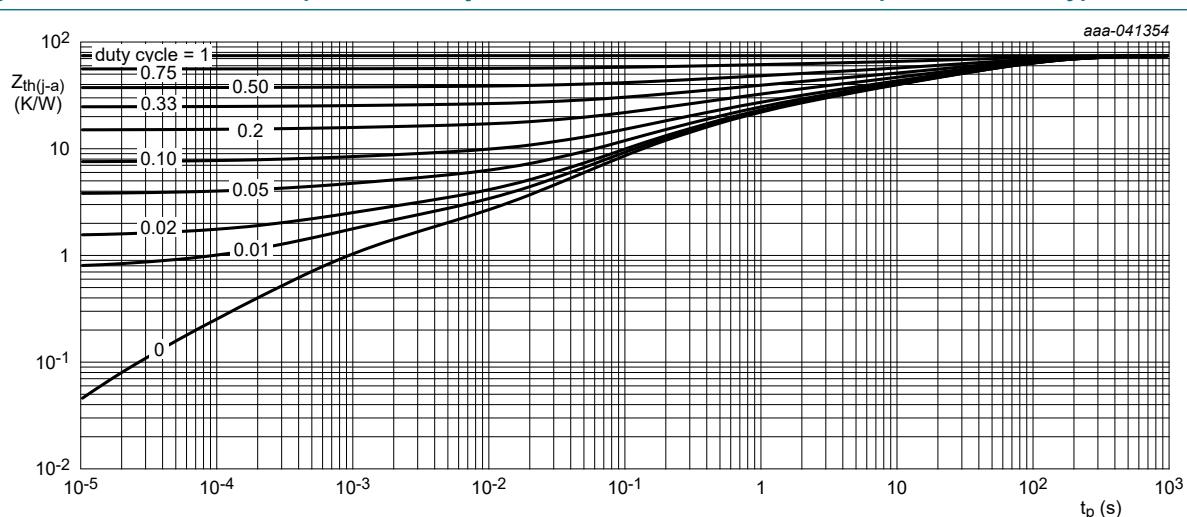
- [1] Device mounted on an FR4 PCB, single-sided, 35  $\mu\text{m}$  copper, tin-plated and standard footprint.  
 [2] Device mounted on an FR4 PCB, single-sided, 35  $\mu\text{m}$  copper, tin-plated, mounting pad for collector 6  $\text{cm}^2$ .  
 [3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.  
 [4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1  $\text{cm}^2$ .  
 [5] Device mounted on a ceramic PCB,  $\text{Al}_2\text{O}_3$ , single-sided, 35  $\mu\text{m}$  copper, tin-plated and standard footprint.



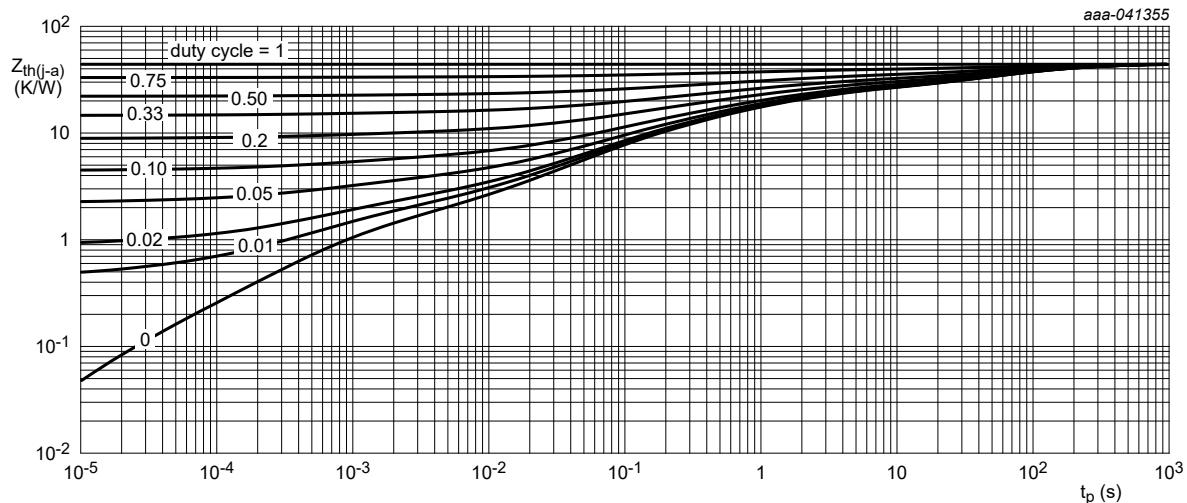
**Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



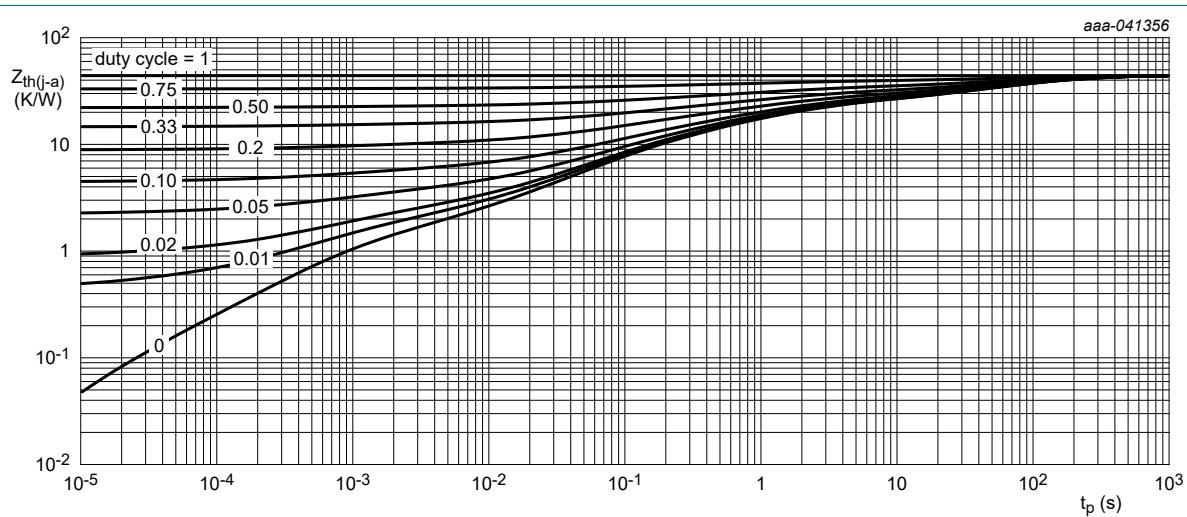
**Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



**Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



**Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



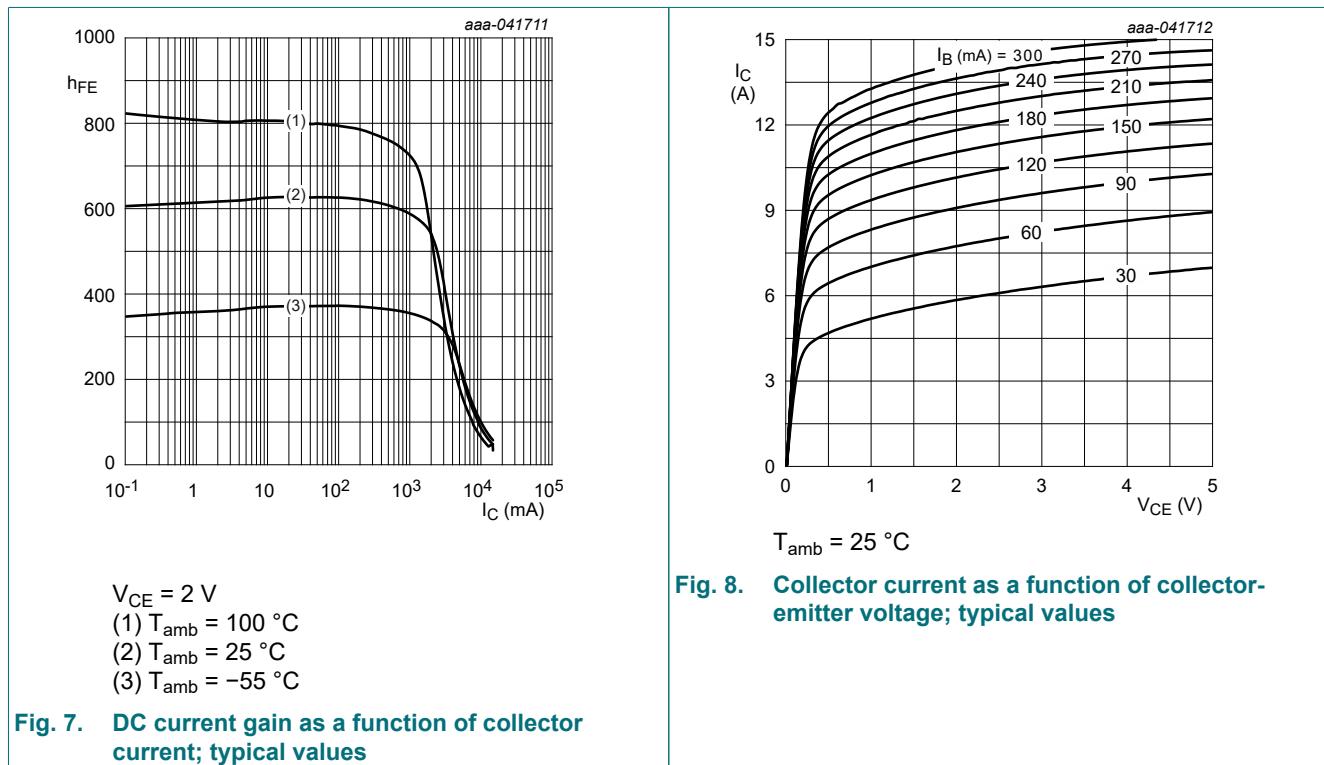
**Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100 \mu A; I_E = 0 A; T_{amb} = 25^\circ C$	60	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 10 mA; I_B = 0 A; T_{amb} = 25^\circ C$	60	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100 \mu A; I_C = 0 A; T_{amb} = 25^\circ C$	5	-	-	V
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 60 V; I_E = 0 A; T_{amb} = 25^\circ C$	-	-	100	nA
		$V_{CB} = 60 V; I_E = 0 A; T_j = 150^\circ C$	-	-	50	μA
$I_{CES}$	collector-emitter cut-off current	$V_{CE} = 48 V; V_{BE} = 0 V; T_{amb} = 25^\circ C$	-	-	100	nA
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A; T_{amb} = 25^\circ C$	-	-	100	nA
$h_{FE}$	DC current gain	$V_{CE} = 2 V; I_C = 0.5 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	300	525	-	
		$V_{CE} = 2 V; I_C = 1 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	300	510	-	
		$V_{CE} = 2 V; I_C = 2 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	250	470	-	
		$V_{CE} = 2 V; I_C = 4 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	150	280	-	
		$V_{CE} = 2 V; I_C = 6 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	75	170	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 1 A; I_B = 10 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	50	80	mV
		$I_C = 1 A; I_B = 50 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	30	50	mV
		$I_C = 2 A; I_B = 40 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	60	145	mV
		$I_C = 4 A; I_B = 40 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	150	320	mV
		$I_C = 4 A; I_B = 200 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	80	150	mV
		$I_C = 6 A; I_B = 300 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	120	210	mV
$R_{CEsat}$	collector-emitter saturation resistance	$I_C = 4 A; I_B = 400 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	18	35	mΩ
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 1 A; I_B = 100 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	0.83	0.9	V
		$I_C = 4 A; I_B = 400 mA; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	1	1.05	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = 2 V; I_C = 2 A; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25^\circ C$	-	0.77	0.85	V

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_d$	delay time	$V_{CC} = 12.5 \text{ V}$ ; $I_C = 1 \text{ A}$ ; $I_{B\text{on}} = 50 \text{ mA}$ ; $I_{B\text{off}} = -50 \text{ mA}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	35	-	ns
$t_r$	rise time		-	50	-	ns
$t_{\text{on}}$	turn-on time		-	85	-	ns
$t_s$	storage time		-	700	-	ns
$t_f$	fall time		-	120	-	ns
$t_{\text{off}}$	turn-off time		-	820	-	ns
$f_T$	transition frequency	$V_{CE} = 10 \text{ V}$ ; $I_C = 100 \text{ mA}$ ; $f = 100 \text{ MHz}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	125	-	MHz
$C_c$	collector capacitance	$V_{CB} = 10 \text{ V}$ ; $I_E = 0 \text{ A}$ ; $i_e = 0 \text{ A}$ ; $f = 1 \text{ MHz}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	30	-	pF



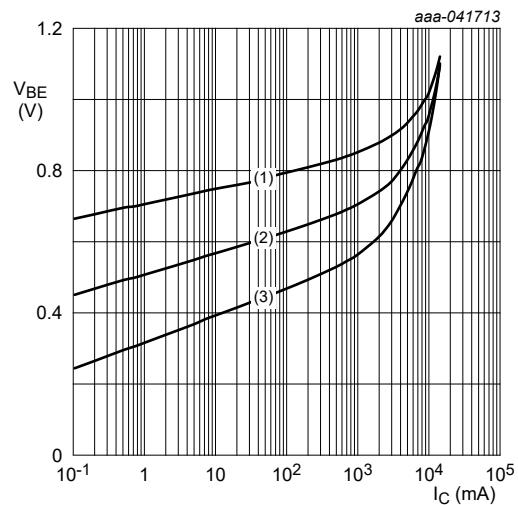


Fig. 9. Base-emitter voltage as a function of collector current; typical values

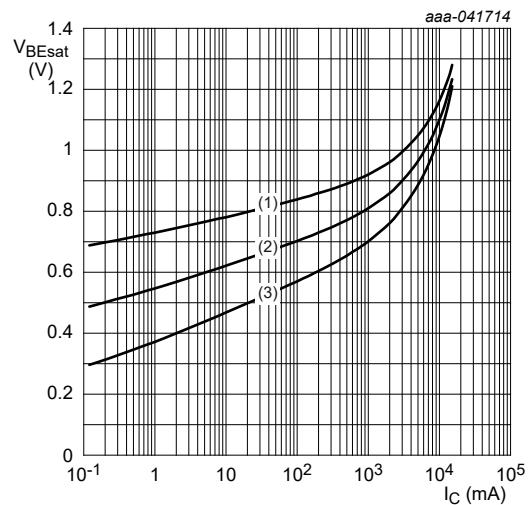


Fig. 10. Base-emitter saturation voltage as a function of collector current; typical values

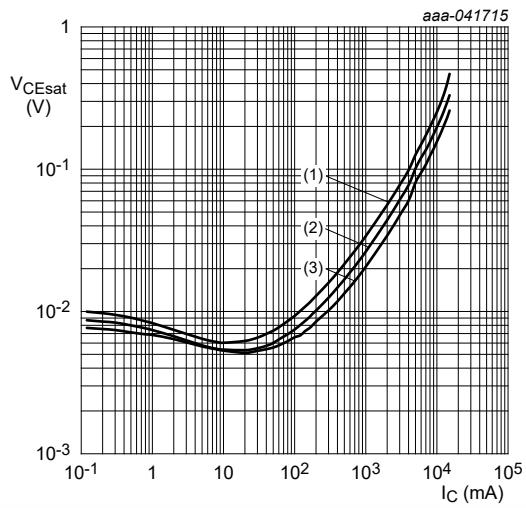


Fig. 11. Collector-emitter saturation voltage as a function of collector current; typical values

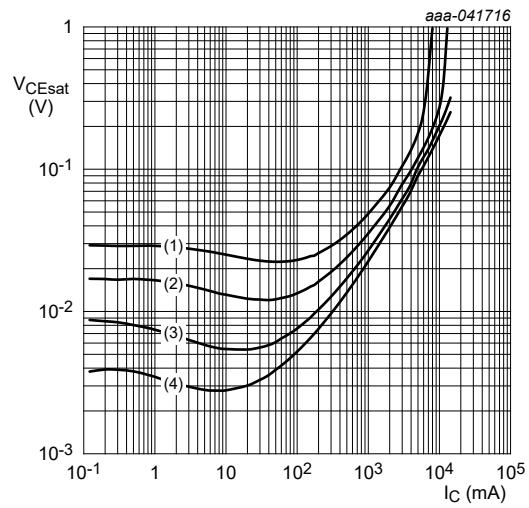
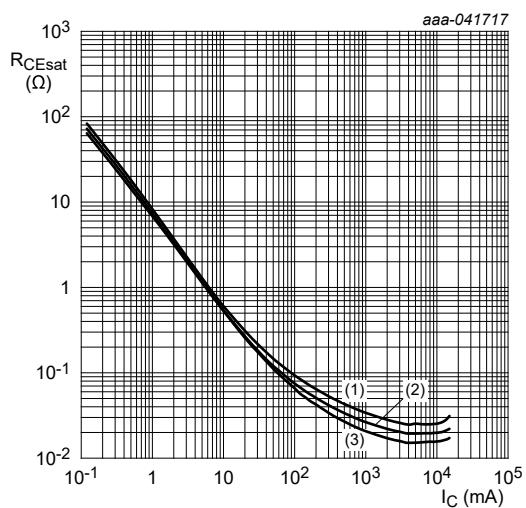
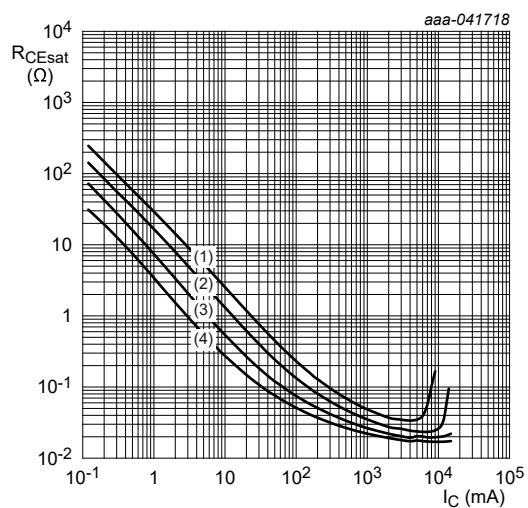


Fig. 12. Collector-emitter saturation voltage as a function of collector current; typical values



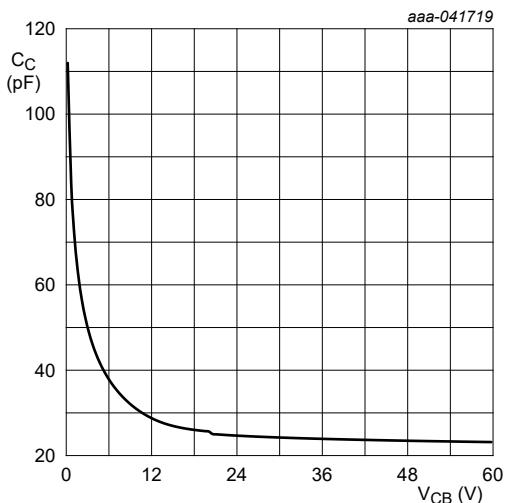
$I_C/I_B = 20$   
 (1)  $T_{amb} = 100 \text{ } ^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ } ^\circ\text{C}$   
 (3)  $T_{amb} = -55 \text{ } ^\circ\text{C}$

Fig. 13. Collector-emitter saturation resistance as a function of collector current; typical values



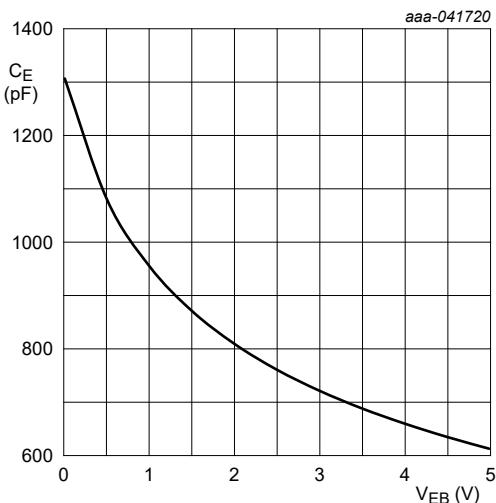
$T_{amb} = 25 \text{ } ^\circ\text{C}$   
 (1)  $I_C/I_B = 100$   
 (2)  $I_C/I_B = 50$   
 (3)  $I_C/I_B = 20$   
 (4)  $I_C/I_B = 10$

Fig. 14. Collector-emitter saturation resistance as a function of collector current; typical values



$f = 1 \text{ MHz}$   
 $T_{amb} = 25 \text{ } ^\circ\text{C}$

Fig. 15. Collector capacitance as a function of collector-base voltage; typical value



$f = 1 \text{ MHz}$   
 $T_{amb} = 25 \text{ } ^\circ\text{C}$

Fig. 16. Emitter capacitance as a function of emitter-base voltage; typical value

## 11. Test information

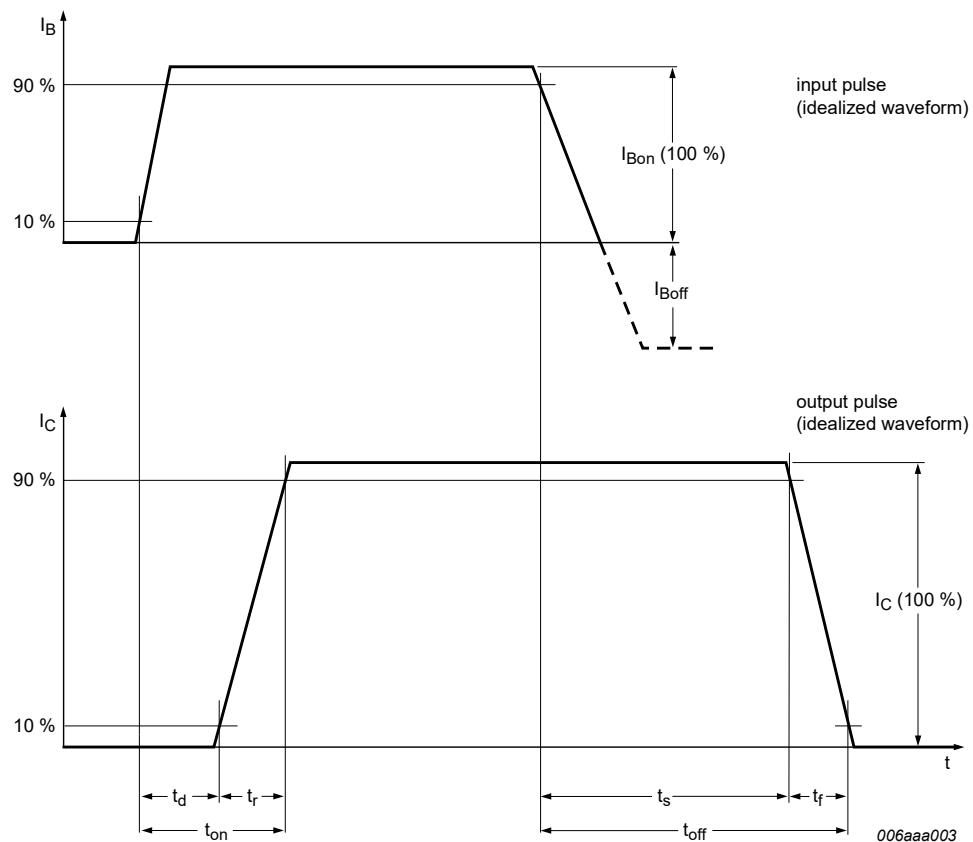


Fig. 17. Switching time definition

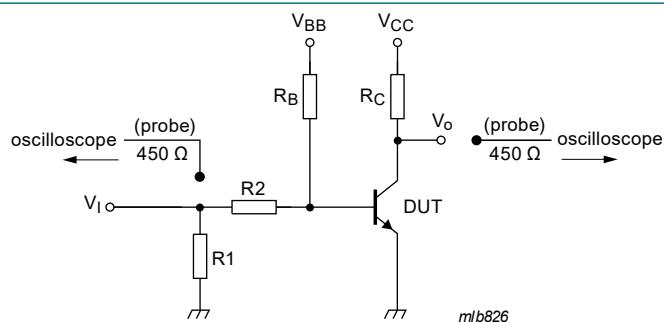


Fig. 18. Test circuit for switching times

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

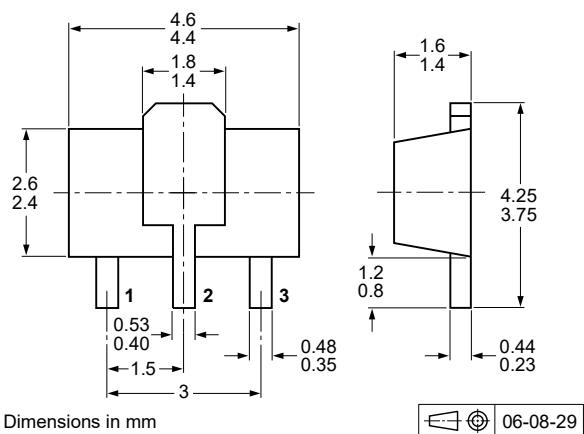


Fig. 19. Package outline SOT89

## 13. Soldering

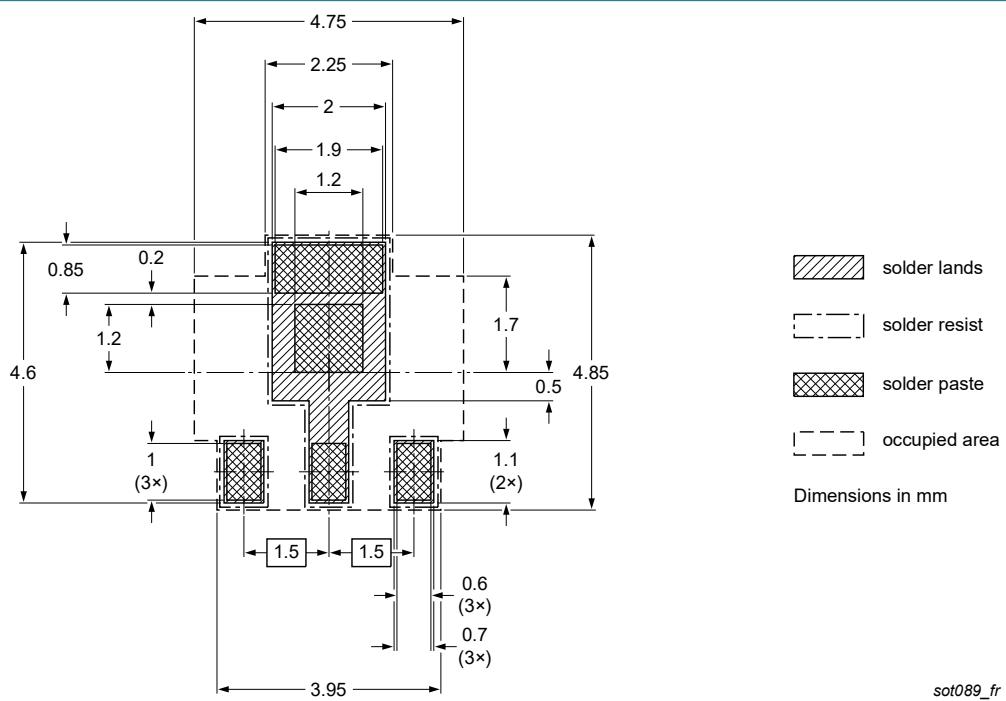


Fig. 20. Reflow soldering footprint for SOT89

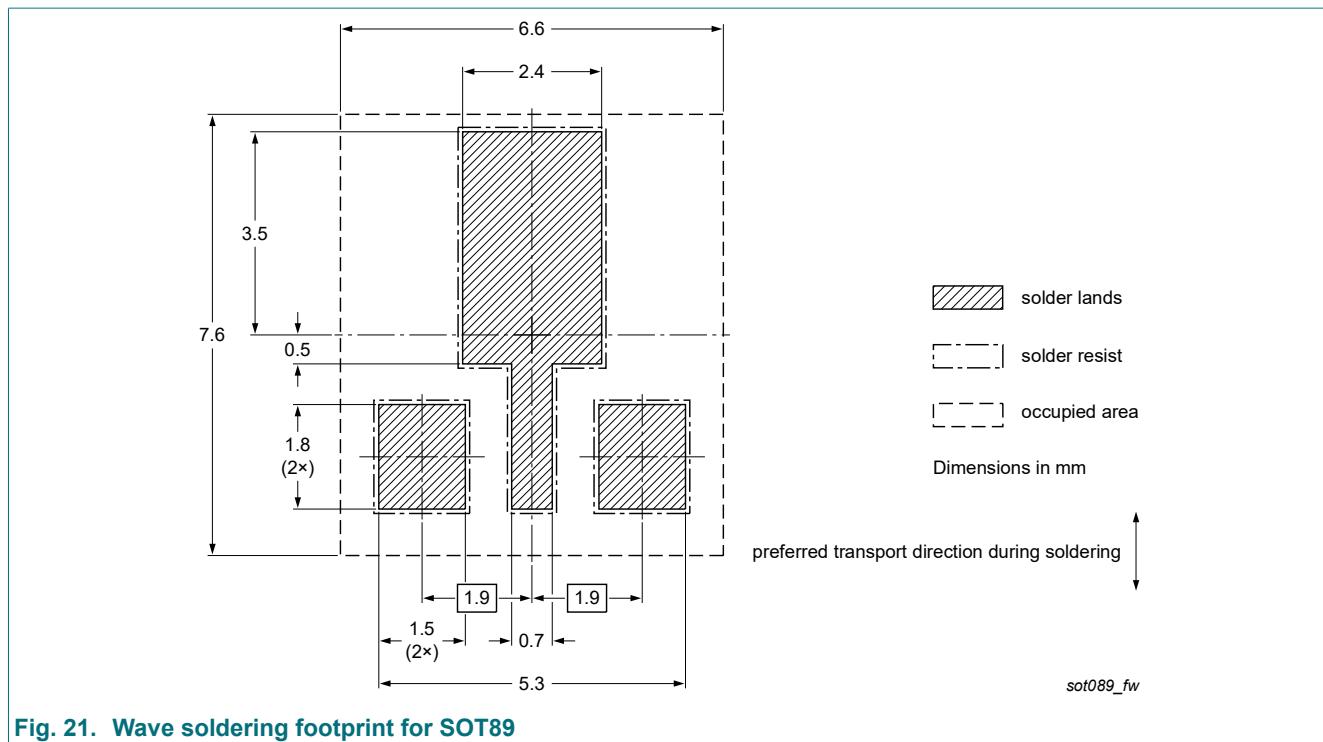


Fig. 21. Wave soldering footprint for SOT89

## 14. Revision history

**Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4041NX v.4	20250116	Product data sheet	-	PBSS4041NX v.3
Modifications:	<ul style="list-style-type: none"><li>Editorial update</li><li>New graphics and values are added.</li></ul>			
PBSS4041NX v.3	20121211	Product data sheet	-	PBSS4041NX v.2
PBSS4041NX v.2	20121010	Product data sheet	-	PBSS4041NX v.1
PBSS4041NX v.1	20100401	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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